

SSC8130GS1

N-Channel Enhancement Mode MOSFET

> Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	ID
30V	±20V	4mΩ@10V	68A
		5.5mΩ@4V5	004

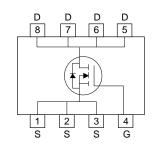
> Description

This SSC8130GS1 uses advanced trench technology to provide excellent RDSON and low gate charge. The complementary MOSFETS may be used to form a level shifted high side switch, and for a host of other applications.

Pin configuration



<u>SOP-8</u>



Pin Configuration (Top View)

> Applications

- Load Switch
- PWM Application
- Power Management

> Ordering Information

Device	Package	Shipping		
SSC8130GS1	SOP-8	4000/Reel		



Marking

(XXYY: Internal Traceability Code)





Symbol	Parameter	Ratings	Unit		
V _{DSS}	Drain-to-Source Voltage		30	V	
V _{GSS}	Gate-to-Source Voltage		±20	V	
	Continuous Drain Current ^d	Tc=25℃	68	A	
ID		Tc=100℃	37		
Idsm	Continuous Drain Current ^a	T _A =25℃	21	A	
		T _A =70℃	15		
Ідм	Pulsed Drain Current ^b		272	А	
D	Power Dissipation ^c	Tc=25℃	30	w	
PD		Tc=100℃	12		
Pdsm	Power Dissipation ^a	T _A =25℃	2.8	w	
		T _A =70℃	1.8		
las	Avalanche Current ^b L=0.5mH Single Pulse		25	А	
Eas	Avalanche Energy ^b L=0.5mH Single Pulse		156	mJ	
TJ	Operation junction temperature		-55~150	°C	
T _{STG}	Storage temperature range		-55~150		

> Absolute Maximum Ratings ($T_A=25^{\circ}$ unless otherwise noted)

> Thermal Resistance Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit	
R _{0JA}	Junction-to-Ambient Thermal Resistance ^a	45	°C/W	
R _{θJC}	Junction-to-Case Thermal Resistance	4.2	°C/W	

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.



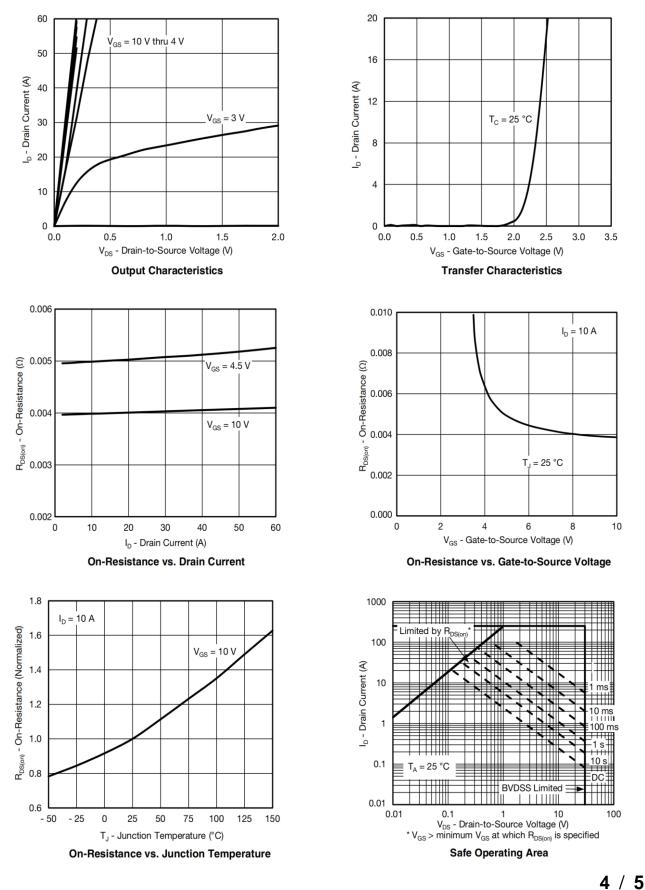


> Electrical Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _(BR) DSS	$V_{GS} = 0V, I_D = 250uA$	30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 uA$	1	1.5	3	V
Drain-Source On-Resistance	R _{DS(on)}	$V_{GS} = 10V, I_D = 15A$		4	5.5	- mΩ
		$V_{GS} = 4.5V, I_D = 12A$		5.5	8	
Zero Gate Voltage Drain Current	loss	$V_{DS} = 24V, V_{GS} = 0V$			1	uA
Gate-Source Leak Current	lgss	$V_{GS} = \pm 20V$, $V_{DS} = 0V$			±100	nA
Transconductance	G _{FS}	$V_{DS} = 5V, I_D = 5A$		21		s
Forward Voltage	Vsd	$V_{GS} = 0V, I_S = 10A$		0.8	1.3	V
Gate Resistance	Rg	$V_{DS} = 0V, f = 1MHz$		1.4		Ω
Input Capacitance	Ciss			2320		pF
Output Capacitance	Coss	$V_{DS} = 15V, V_{GS} = 0V,$		267		
Reverse Transfer Capacitance	Crss	f = 1MHz		223		
Total Gate Charge	Q _G			32		nC
Gate to Source Charge	Q _{GS}	$V_{GS} = 10V, V_{DS} = 15V,$ $I_{D} = 20A$		7.4		
Gate to Drain Charge	Q _{GD}	ID = 20A		8.4		
Turn-on Delay Time	T _{D(ON)}			9.2		
Rise Time	Tr	$V_{GS} = 10V, V_{DS} = 15V,$ $R_L = 1.5\Omega, R_G = 3\Omega$		64		ns
Turn-off Delay Time	T _{D(OFF)}			81		
Fall Time	T _f			46		
Diode Recovery Time	Trr	I⊧=20A, di/dt=500A/us		14		ns
Diode Recovery Charge	Qrr	I _F =20A, di/dt=500A/us		5.8		nC

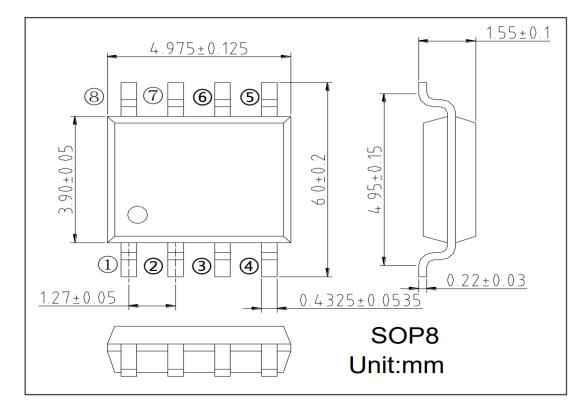


> Typical Performance Characteristics (T_A=25 $^{\circ}$ C unless otherwise noted)





Package Information



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